ESDR0502B, SZESDR0502B

ESD Protection Diode

Ultra-Low Capacitance

The ESDR0502B is designed to protect voltage sensitive components from damage due to ESD in applications that require ultra low capacitance to preserve signal integrity. Excellent clamping capability, low leakage and fast response time are combined with an ultra low diode capacitance of 0.5 pF to provide best in class protection from IC damage due to ESD. The small SC-75 package is ideal for designs where board space is at a premium. The ESDR0502B can be used to protect two uni-directional lines or one bi-directional line. When used to protect one bi-directional line, the effective capacitance is 0.25 pF. Because of its low capacitance, it is well suited for protecting high frequency signal lines such as USB2.0 high speed and antenna line applications.

Specification Features:

- Low Capacitance 0.5 pF Typical
- Low Clamping Voltage, Low Leakage
- Small Body Outline Dimensions: 0.063" x 0.063" (1.60 mm x 1.60 mm)
- Stand-off Voltage: 5 V
- Response Time is Typically < 1.0 ns
- IEC61000-4-2 Level 4 ESD Protection ISO10605 330 pF/2 kΩ ±17 kV (Contact)
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- This is a Pb–Free Device

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic

Epoxy Meets UL 94 V-0

LEAD FINISH: 100% Matte Sn (Tin)

MOUNTING POSITION: Any

QUALIFIED MAX REFLOW TEMPERATURE: 260°C Device Meets MSL 1 Requirements

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|-------------|------|
| IEC 61000-4-2 Contact (ESD) IEC 61000-4-2 Air (ESD) | ESD | ±11 ±15 | kV |
| Peak Surge Power (8 x 20 µs) | P _{pk} | 20 | W |
| Peak Surge Current (8 x 20 µs) | I _{pp} | 2.0 | А |
| Total Power Dissipation on FR–5 Board (Note 1) @ $T_A = 25^{\circ}C$ | P _D | 150 | mW |
| Storage Temperature Range | T _{stg} | –55 to +150 | °C |
| Junction Temperature Range | TJ | –55 to +150 | °C |
| Lead Solder Temperature – Maximum (10 Second Duration) | ΤL | 260 | °C |

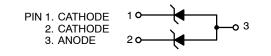
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

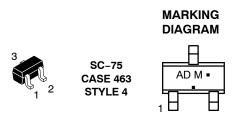
1. $FR-5 = 1.0 \times 0.75 \times 0.62$ in.



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AD = Device Code M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|--------------------|-----------------------|
| ESDR0502BT1G | SC-75 (Pb-Free) | 3000/Tape & Reel |
| SZESDR0502BT1G | SC–75 (Pb–Free) | 3000/Tape & Reel |

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

See Application Note AND8308/D for further description of survivability specs.

DEVICE MARKING INFORMATION

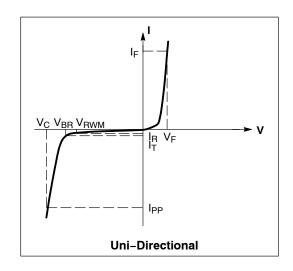
See specific marking information in the device marking column of the Electrical Characteristics tables starting on page 2 of this data sheet.

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ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

| Symbol | Parameter | | | | | |
|------------------|--|--|--|--|--|--|
| I _{PP} | Maximum Reverse Peak Pulse Current | | | | | |
| V _C | Clamping Voltage @ IPP | | | | | |
| V _{RWM} | Working Peak Reverse Voltage | | | | | |
| I _R | Maximum Reverse Leakage Current @ V _{RWM} | | | | | |
| V _{BR} | Breakdown Voltage @ I _T | | | | | |
| Ι _Τ | Test Current | | | | | |
| ١ _F | Forward Current | | | | | |
| V _F | Forward Voltage @ I _F | | | | | |
| P _{pk} | Peak Power Dissipation | | | | | |
| С | Capacitance @ $V_R = 0$ and f = 1.0 MHz | | | | | |



| | | V _{RWM} (V) | I _R (μΑ) @ V _{RWM} | V _{BR} (V) @ I _T (Note 2) | г | C (p uni-dire (Not | ectional | C (pF), bi-directional (Note 4) | | V _C (V) @ I _{PP} = 1 A (Note 5) | Vc |
|-----------|-------------------|-------------------------|---|---|-----|--------------------------|----------|---------------------------------------|------|---|-------------------------------------|
| Device* | Device Marking | Max | Max | Min | mA | Тур | Max | Тур | Max | Max | Per IEC61000- 4-2 (Note 6) |
| ESDR0502B | AD | 5.0 | 1.0 | 5.8 | 1.0 | 0.5 | 0.9 | 0.25 | 0.45 | 15 | Figures 1 and 2 |

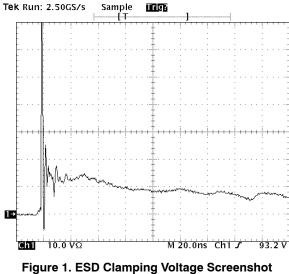
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. *Include SZ-prefix devices where applicable.

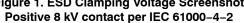
2. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C. 3. Uni-directional capacitance at f = 1 MHz, $V_R = 0 V$, $T_A = 25^{\circ}C$ (pin1 to pin 3; pin 2 to pin 3).

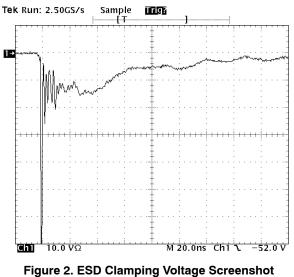
4. Bi-directional capacitance at f = 1 MHz, V_R = 0 V, T_A = 25°C (pin1 to pin 2).

5. Surge current waveform per Figure 5.

6. Typical waveform. For test procedure see Figures 3 and 4 and Application Note AND8307/D.





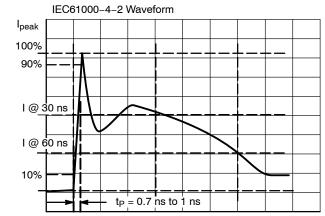


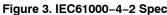
Negative 8 kV contact per IEC 61000-4-2

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IEC 61000-4-2 Spec.

| Level | Test Volt- age (kV) | First Peak Current (A) | Current at 30 ns (A) | Current at 60 ns (A) |
|-------|------------------------|------------------------------|-------------------------|-------------------------|
| 1 | 2 | 7.5 | 4 | 2 |
| 2 | 4 | 15 | 8 | 4 |
| 3 | 6 | 22.5 | 12 | 6 |
| 4 | 8 | 30 | 16 | 8 |





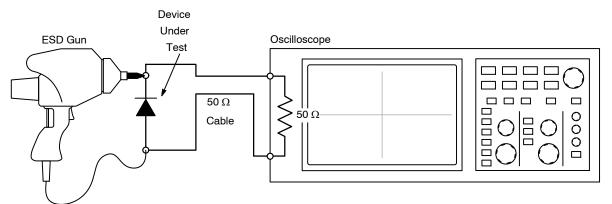


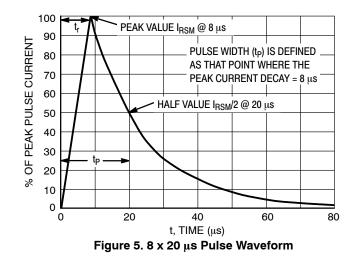
Figure 4. Diagram of ESD Test Setup

The following is taken from Application Note AND8308/D – Interpretation of Datasheet Parameters for ESD Devices.

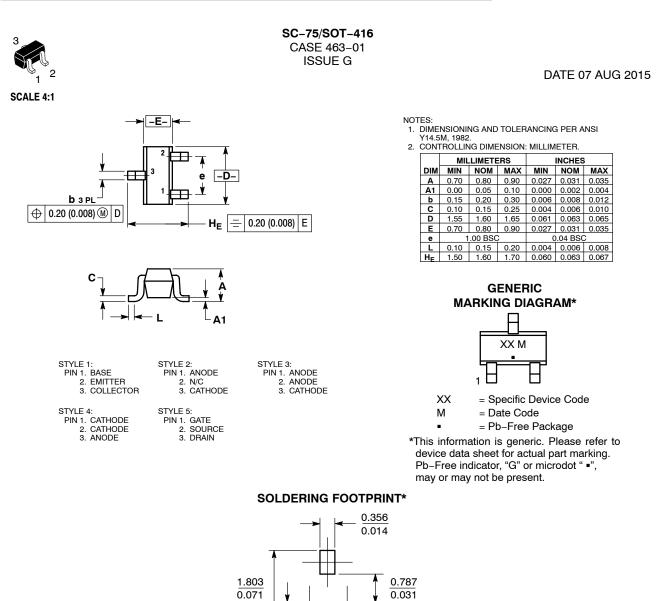
ESD Voltage Clamping

For sensitive circuit elements it is important to limit the voltage that an IC will be exposed to during an ESD event to as low a voltage as possible. The ESD clamping voltage is the voltage drop across the ESD protection diode during an ESD event per the IEC61000–4–2 waveform. Since the IEC61000–4–2 was written as a pass/fail spec for larger

systems such as cell phones or laptop computers it is not clearly defined in the spec how to specify a clamping voltage at the device level. ON Semiconductor has developed a way to examine the entire voltage waveform across the ESD protection diode over the time domain of an ESD pulse in the form of an oscilloscope screenshot, which can be found on the datasheets for all ESD protection diodes. For more information on how ON Semiconductor creates these screenshots and how to interpret them please refer to AND8307/D.







*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

1.000

0.039

SCALE 10:1

mm

inches

0.508

0.020

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 SC-75/SOT-416
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